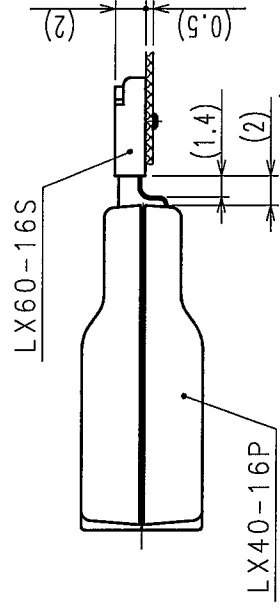
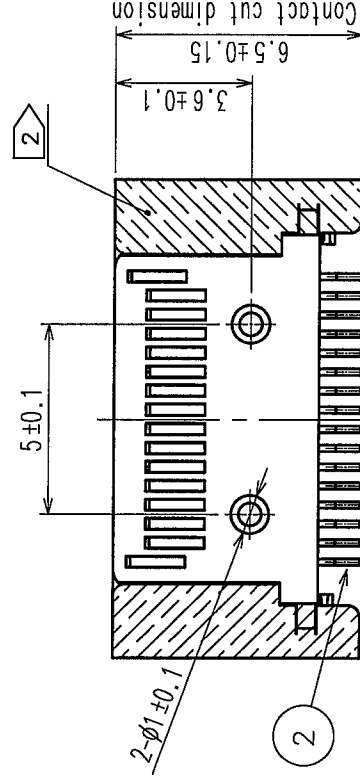
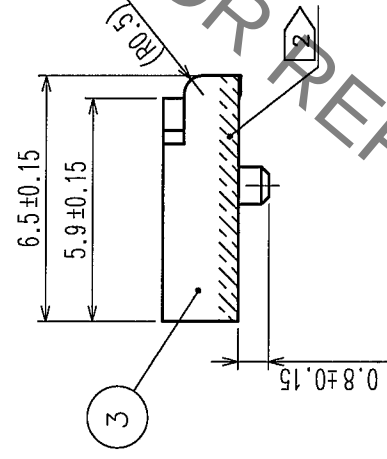
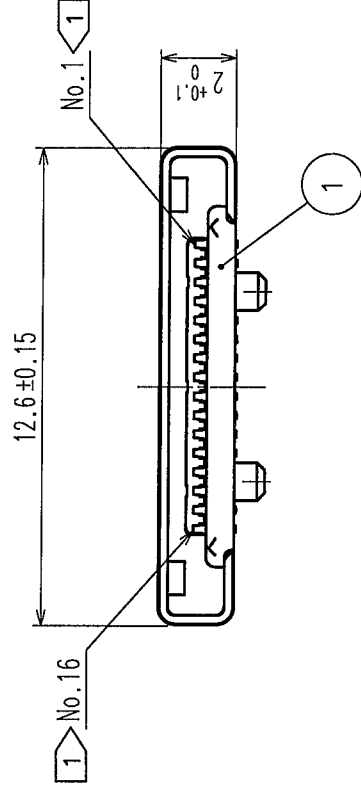
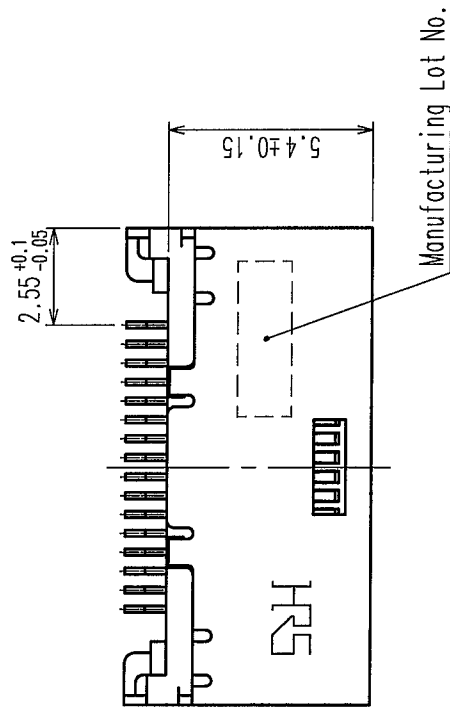
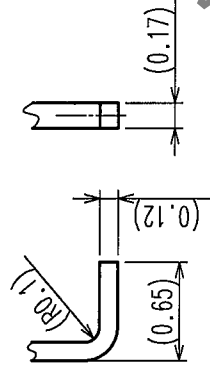


COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE

Mated (2:1)

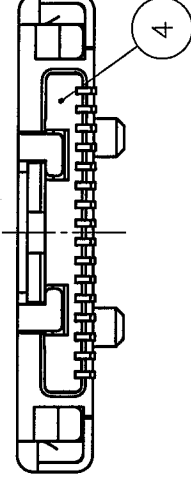
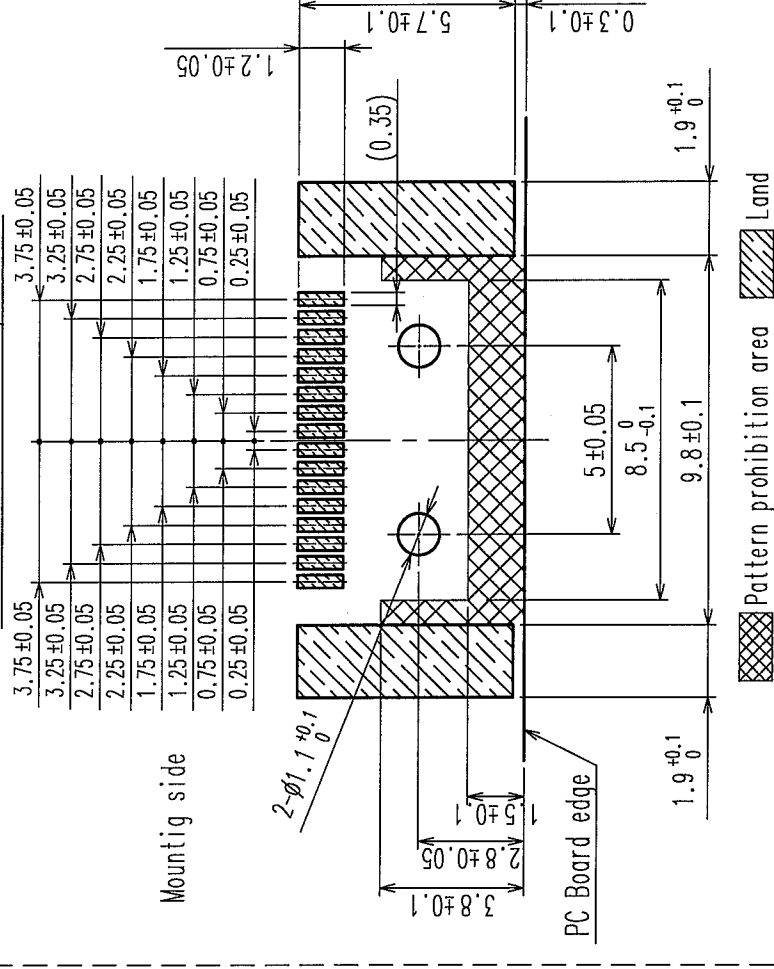


Dimensions SMT lead (20:1)



0.25±0.05	0.25±0.05
0.75±0.05	0.75±0.05
1.25±0.05	1.25±0.05
1.75±0.05	1.75±0.05
2.25±0.05	2.25±0.05
2.75±0.05	2.75±0.05
3.25±0.05	3.25±0.05
3.75±0.05	3.75±0.05

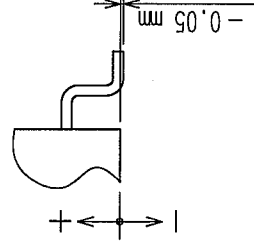
Recommended PC board pattern



Notes) 1. No.1 and 16 pin are dedicated to sequence contact.

2. shows selective gold flush plated area.

3. SMT contact coplanarity should be less than 0.1mm within the range from -0.1mm to +0.05mm.



2	Copper alloy	Contact: Selective gold plating (0.3μm) Lead: Selective gold flush plating	4	PA9T(9TNYlon)	Color:black	UL94V-0
1	PA9T(9TNYlon)	Color:black	3	Stainless steel	Selective gold flush plating	

NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
CODE NO. (OLD)					
DRAWN					
DESIGNED					
CHECKED					
APPROVED					
RELEASED					

DRAWING NO.		PART NO.	
EDC3-124882		LX60-16S	
SCALE		CODE NO.	
5 : 1		CL245-0001-0	
UNITS		FORM NO. 2	
mm		8	

HRS

HIROSE ELECTRIC CO., LTD

